CPC COOPERATIVE PATENT CLASSIFICATION

CHEMISTRY: METALLURGY C

(NOTES omitted)

METALLURGY

C30 **CRYSTAL GROWTH**

C30B SINGLE-CRYSTAL GROWTH (by using ultra-high pressure, e.g. for the formation of diamonds, B01J 3/06); UNIDIRECTIONAL SOLIDIFICATION OF EUTECTIC MATERIAL OR UNIDIRECTIONAL DEMIXING OF EUTECTOID MATERIAL; REFINING BY ZONE-MELTING OF MATERIAL (zone-refining of metals or alloys C22B); PRODUCTION OF A HOMOGENEOUS POLYCRYSTALLINE MATERIAL WITH DEFINED STRUCTURE (casting of metals, casting of other substances by the same processes or devices B22D; working of plastics B29; modifying the physical structure of metals or alloys C21D, C22F); SINGLE CRYSTALS OR HOMOGENEOUS POLYCRYSTALLINE MATERIAL WITH DEFINED STRUCTURE; AFTER-TREATMENT OF SINGLE CRYSTALS OR A HOMOGENEOUS POLYCRYSTALLINE MATERIAL WITH DEFINED STRUCTURE (for producing

semiconductor devices or parts thereof H01L, H10); APPARATUS THEREFOR

NOTES

- 1. In this subclass, the following expressions are used with the meaning indicated:
 - "single-crystal" includes also twin crystals and a predominantly single crystal product;
 - · "homogeneous polycrystalline material" means a material with crystal particles, all of which have the same chemical composition:
 - "defined structure" means the structure of a material with grains which are oriented in a preferential way or have larger dimensions than normally obtained.
- 2. In this subclass:
 - the preparation of crystals or a homogeneous polycrystalline material with defined structure of particular materials or shapes is classified in the group for the process as well as in group C30B 29/00;
 - an apparatus specially adapted for a specific process is classified in the appropriate group for the process. Apparatus to be used in more than one kind of process is classified in group C30B 35/00.

WARNING

In this subclass non-limiting references (in the sense of paragraph 39 of the Guide to the IPC) may still be displayed in the scheme.

| Single-c | rystal | grow | rth fi | rom | solids | or | gels |
|----------|--------|------|--------|-----|--------|----|------|
| | | | | | | | |

| 1/00 | Single-crystal growth directly from the solid state (unidirectional demixing of eutectoid materials C30B 3/00; under a protective fluid C30B 27/00) |
|-------|---|
| 1/02 | • by thermal treatment, e.g. strain annealing (C30B 1/12 takes precedence) |
| 1/023 | • • {from solids with amorphous structure} |
| 1/026 | {Solid phase epitaxial growth through a disordered intermediate layer} |
| 1/04 | Isothermal recrystallisation |
| 1/06 | Recrystallisation under a temperature gradient |
| 1/08 | Zone recrystallisation |
| 1/10 | by solid state reactions or multi-phase diffusion |
| 1/12 | by pressure treatment during the growth |
| 3/00 | Unidirectional demixing of eutectoid materials |
| 5/00 | Single-crystal growth from gels (under a protective fluid C30B 27/00) |

. with addition of doping materials

processes }

Single-crystal growth from liquids; Unidirectional solidification of eutectic materials

| 7/00 | Single-crystal growth from solutions using solvents which are liquid at normal temperature, e.g. aqueous solutions (from molten solvents C30B 9/00; |
|-------|---|
| | by normal or gradient freezing C30B 11/00; under a |
| | protective fluid <u>C30B 27/00</u>) |
| 7/005 | • {Epitaxial layer growth} |
| 7/02 | by evaporation of the solvent |
| 7/04 | using aqueous solvents |
| 7/06 | • using non-aqueous solvents |
| 7/08 | by cooling of the solution |
| 7/10 | by application of pressure, e.g. hydrothermal |
| | processes |
| 7/105 | • • {using ammonia as solvent, i.e. ammonothermal |

| 7/12 | • by electrolysis | 13/14 | Crucibles or vessels |
|--------|---|--------|--|
| 7/14 | the crystallising materials being formed by chemical | 13/16 | Heating of the molten zone |
| | reactions in the solution | 13/18 | the heating element being in contact with, or immersed in, the molten zone |
| 9/00 | Single-crystal growth from melt solutions using | 13/20 | by induction, e.g. hot wire technique (C30B 13/18) |
| | molten solvents (by normal or gradient freezing | 13/20 | takes precedence) |
| | <u>C30B 11/00</u> ; by zone-melting <u>C30B 13/00</u> ; by | 13/22 | by irradiation or electric discharge |
| | crystal pulling C30B 15/00; on immersed seed | 13/24 | using electromagnetic waves |
| | crystal <u>C30B 17/00</u> ; by liquid phase epitaxial growth | 13/26 | Stirring of the molten zone |
| 9/02 | C30B 19/00; under a protective fluid C30B 27/00) • by evaporation of the molten solvent | 13/28 | Controlling or regulating |
| 9/02 | by evaporation of the motion solvent by cooling of the solution | 13/285 | • • {Crystal holders, e.g. chucks} |
| 9/04 | by cooling of the solution using as solvent a component of the crystal | 13/30 | Stabilisation or shape controlling of the molten |
| | composition | | zone, e.g. by concentrators, by electromagnetic fields; Controlling the section of the crystal |
| 9/08 | • using other solvents | 13/32 | Mechanisms for moving either the charge or the |
| 9/10 | Metal solvents | 13,32 | heater |
| 9/12 | Salt solvents, e.g. flux growth | 13/34 | • characterised by the seed, e.g. by its |
| 9/14 | by electrolysis | -2,2 | crystallographic orientation |
| 11/00 | Single-crystal growth by normal freezing or freezing under temperature gradient, e.g. | 15/00 | Single-crystal growth by pulling from a melt, |
| | Bridgman-Stockbarger method (C30B 13/00, | | e.g. Czochralski method (under a protective fluid |
| | C30B 15/00, C30B 17/00, C30B 19/00 take | | <u>C30B 27/00</u>) |
| | precedence; under a protective fluid C30B 27/00) | 15/002 | • {Continuous growth} |
| 11/001 | • {Continuous growth} | 15/005 | • {Simultaneous pulling of more than one crystal} |
| 11/002 | • {Crucibles or containers for supporting the melt} | 15/007 | • {Pulling on a substrate} |
| 11/003 | {Heating or cooling of the melt or the crystallised material} | 15/02 | adding crystallising materials or reactants forming it in situ to the melt |
| 11/005 | • {by irradiation or electric discharge} | 15/04 | • adding doping materials, e.g. for n-p-junction |
| 11/006 | • {Controlling or regulating} | 15/06 | Non-vertical pulling |
| 11/007 | • {Mechanisms for moving either the charge or the | 15/08 | Downward pulling |
| | heater} | 15/10 | Crucibles or containers for supporting the melt |
| 11/008 | {using centrifugal force to the charge} | 15/12 | Double crucible methods |
| 11/02 | without using solvents (<u>C30B 11/06</u> takes | 15/14 | • Heating of the melt or the crystallised materials |
| | precedence) | 15/16 | by irradiation or electric discharge |
| 11/04 | adding crystallising materials or reactants forming it in situ to the melt | 15/18 | • using direct resistance heating in addition to other methods of heating, e.g. using Peltier heat |
| 11/06 | at least one but not all components of the crystal composition being added | 15/20 | • Controlling or regulating (controlling or regulating in general <u>G05</u>) |
| 11/065 | • • • {before crystallising, e.g. synthesis} | 15/203 | {the relationship of pull rate (v) to axial thermal |
| 11/08 | every component of the crystal composition being | | gradient (G)} |
| | added during the crystallisation | 15/206 | • • {the thermal history of growing the ingot} |
| 11/10 | • • Solid or liquid components, e.g. Verneuil method | 15/22 | Stabilisation or shape controlling of the molten zone near the pulled crystal; Controlling the |
| 11/12 | Vaporous components, e.g. vapour-liquid- | | section of the crystal |
| | solid-growth | 15/24 | using mechanical means, e.g. shaping guides |
| 11/14 | characterised by the seed, e.g. its crystallographic orientation | | (shaping dies for edge-defined film-fed crystal growth C30B 15/34) |
| 12/00 | | 15/26 | • • using television detectors; using photo or X-ray |
| 13/00 | Single-crystal growth by zone-melting; Refining | | detectors |
| | by zone-melting (C30B 17/00 takes precedence; by changing the cross-section of the treated solid | 15/28 | • • using weight changes of the crystal or the melt, e.g. flotation methods |
| | C30B 15/00; under a protective fluid C30B 27/00; for | 15/30 | . Mechanisms for rotating or moving either the melt |
| | the growth of homogeneous polycrystalline material with defined structure C30B 28/00) | | or the crystal (flotation methods <u>C30B 15/28</u>) |
| 13/005 | • {Continuous growth} | 15/305 | • • {Stirring of the melt} |
| 13/003 | Continuous growingZone-melting with a solvent, e.g. travelling solvent | 15/32 | • Seed holders, e.g. chucks |
| | process | 15/34 | Edge-defined film-fed crystal-growth using dies or slits |
| 13/04 | Homogenisation by zone-levelling | 15/36 | characterised by the seed, e.g. its crystallographic |
| 13/06 | the molten zone not extending over the whole cross- section | 4=100 | orientation |
| 13/08 | adding crystallising materials or reactants forming it | 17/00 | Single-crystal growth onto a seed which remains in |
| 10/10 | in situ to the molten zone | | the melt during growth, e.g. Nacken-Kyropoulos method (C30B 15/00 takes precedence) |
| 13/10 | with addition of doping materials | | • |
| 13/12 | in the gaseous or vapour state | 19/00 | Liquid-phase epitaxial-layer growth |

| 10/02 | : | 25/16 | C |
|--|--|--|--|
| 19/02 | using molten solvents, e.g. flux | 25/16 | Controlling or regulating (controlling or regulating in general <u>G05</u>) |
| 19/04 | • • the solvent being a component of the crystal | 25/165 | |
| 10/06 | composition | | • • • {the flow of the reactive gases} |
| 19/06 | Reaction chambers; Boats for supporting the melt; Substrate holders | 25/18 | characterised by the substrate |
| 19/061 | • • {Tipping system, e.g. by rotation} | 25/183 | • • { being provided with a buffer layer, e.g. a lattice matching layer} |
| | | 25/196 | |
| 19/062 | • • {Vertical dipping system} | 25/186 | • { being specially pre-treated by, e.g. chemical or physical means} |
| 19/063 | • • {Sliding boat system} | 25/20 | |
| 19/064 | • • {Rotating sliding boat system} | 23/20 | • • • the substrate being of the same materials as the epitaxial layer |
| 19/065 | • • {Multiple stacked slider system} | 25/205 | • • • {the substrate being of insulating material} |
| 19/066 | • • {Injection or centrifugal force system} | 25/203 | |
| 19/067 | • • {Boots or containers} | 23/22 | Sandwich processes |
| 19/068 | • • {Substrate holders} | 27/00 | Single-crystal growth under a protective fluid |
| 19/08 | . Heating of the reaction chamber or the substrate | 27/02 | by pulling from a melt |
| 19/10 | Controlling or regulating (controlling or regulating) | •0.10.0 | |
| | in general <u>G05</u>) | 28/00 | Production of homogeneous polycrystalline |
| 19/103 | • • {Current controlled or induced growth} | | material with defined structure |
| 19/106 | • • {adding crystallising material or reactants | 28/02 | directly from the solid state |
| | forming it <u>in situ</u> to the liquid} | 28/04 | • from liquids |
| 19/12 | characterised by the substrate | 28/06 | by normal freezing or freezing under temperature |
| 21/00 | Unidirectional solidification of eutectic materials | | gradient |
| 21/02 | by normal casting or gradient freezing | 28/08 | • • by zone-melting |
| 21/02 | by normal casting of gradient freezing by zone-melting | 28/10 | • • by pulling from a melt |
| | • | 28/12 | directly from the gas state |
| 21/06 | • by pulling from a melt | 28/14 | by chemical reaction of reactive gases |
| Single-crysts | al growth from vapours | 29/00 | Single crystals or homogeneous polycrystalline |
| bligic crysu | ar grown from rupours | 29/00 | material with defined structure characterised by |
| 23/00 | Single-crystal growth by condensing evaporated or | | the material or by their shape |
| | sublimed materials | | |
| | <u>NOTE</u> | | NOTES |
| | Crowns C20D 22/002 C20D 22/005 | | 1. In groups <u>C30B 29/02</u> - <u>C30B 29/54</u> , the last place |
| | | | |
| | Groups C30B 23/002 - C30B 23/005 take precedence over groups | | priority rule is applied, i.e. at each hierarchical |
| | take precedence over groups | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the |
| | take precedence over groups C30B 23/007 - C30B 23/08 | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last |
| 23/002 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. |
| 23/002 23/005 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of |
| 23/005 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • {Controlling or regulating flux or flow of depositing species or vapour} | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version |
| 23/005 23/007 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the |
| 23/005 23/007 23/02 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 |
| 23/005 23/007 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the |
| 23/005 23/007 23/02 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 |
| 23/005 23/007 23/02 23/025 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate | 29/02 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the |
| 23/005 23/007 23/02 23/025 23/04 23/06 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks | 29/02 29/04 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. |
| 23/005 23/007 23/02 23/025 23/04 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate | | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements |
| 23/005 23/007 23/02 23/025 23/04 23/06 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated | 29/04 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond |
| 23/005 23/007 23/02 23/025 23/04 23/06 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated • • • {Heating of the substrate} | 29/04 29/06 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated • • • {Heating of the substrate} • • • {Heating of the material to be evaporated} | 29/04 29/06 29/08 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated • • • {Heating of the substrate} • • • {Heating of the material to be evaporated} • • • {Heating of the material to be evaporated} • • • by condensing ionised vapours (by reactive sputtering C30B 25/06) | 29/04 29/06 29/08 29/10 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of | 29/04 29/06 29/08 29/10 29/12 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions • Halides |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated • • • {Heating of the substrate} • • • {Heating of the material to be evaporated} • • • {Heating of the material to be reactive sputtering C30B 25/06} Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition | 29/04 29/06 29/08 29/10 29/12 29/14 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 | take precedence over groups C30B 23/007 - C30B 23/08 • {Controlling or regulating} • • {Controlling or regulating flux or flow of depositing species or vapour} • {Growth of whiskers or needles} • Epitaxial-layer growth • • {characterised by the substrate} • • Pattern deposit, e.g. by using masks • • Heating of the deposition chamber, the substrate or the materials to be evaporated • • • {Heating of the substrate} • • • {Heating of the material to be evaporated} • • • {Heating of the material to be reactive sputtering C30B 25/06} Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions • Halides • Phosphates • Oxides |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth {characterised by the substrate} Pattern deposit, e.g. by using masks Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions • Halides • Phosphates • Oxides • Quartz • Aluminium oxides |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Quartz Aluminium oxides Complex oxides |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions • Halides • Phosphates • Oxides • Quartz • Aluminium oxides |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/025 25/025 25/04 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} {Heating of the material to be reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. • Elements • Diamond • Silicon • Germanium • Inorganic compounds or compositions • Halides • Phosphates • Oxides • Quartz • Aluminium oxides • Complex oxides • (based on rare earth copper oxides, e.g. high |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Quartz Aluminium oxides Sased on rare earth copper oxides, e.g. high T-superconductors} |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/025 25/025 25/04 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Sased on rare earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 25/08 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials therefor | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Sale on rare earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 25/08 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials therefor . Heating of the reaction chamber or the substrate | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Saluminium oxides Massed on rare earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or Al, e.g. ortho ferrites |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 25/08 25/10 25/105 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials therefor . Heating of the reaction chamber or the substrate {by irradiation or electric discharge} | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Saluminium oxides May be seen a rare earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or Al, e.g. ortho ferrites with formula BMe ₂ O ₄ , wherein B is Mg, Ni, |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 25/08 25/10 25/105 25/12 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials therefor . Heating of the reaction chamber or the substrate . {by irradiation or electric discharge} . Substrate holders or susceptors | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Complex oxides What are earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or Al, e.g. ortho ferrites with formula BMe ₂ O ₄ , wherein B is Mg, Ni, Co, Al, Zn, or Cd and Me is Fe, Ga, Sc, Cr, |
| 23/005 23/007 23/02 23/025 23/04 23/06 23/063 23/066 23/08 25/00 25/005 25/02 25/025 25/04 25/06 25/08 25/10 25/105 | take precedence over groups C30B 23/007 - C30B 23/08 . {Controlling or regulating} . {Controlling or regulating flux or flow of depositing species or vapour} . {Growth of whiskers or needles} . Epitaxial-layer growth . {characterised by the substrate} . Pattern deposit, e.g. by using masks . Heating of the deposition chamber, the substrate or the materials to be evaporated {Heating of the substrate} {Heating of the material to be evaporated} . by condensing ionised vapours (by reactive sputtering C30B 25/06) Single-crystal growth by chemical reaction of reactive gases, e.g. chemical vapour-deposition growth . {Growth of whiskers or needles} . Epitaxial-layer growth . {Continuous growth} . Pattern deposit, e.g. by using masks . by reactive sputtering . Reaction chambers; Selection of materials therefor . Heating of the reaction chamber or the substrate {by irradiation or electric discharge} | 29/04 29/06 29/08 29/10 29/12 29/14 29/16 29/18 29/20 29/22 29/225 | priority rule is applied, i.e. at each hierarchical level, in the absence of an indication to the contrary, a material is classified in the last appropriate place. 2. Attention is drawn to Note (3) after the title of section C, which Note indicates to which version of the Periodic Table of chemical elements the CPC refers. In this group, the system used is the 8 group system indicated by Roman numerals in the Periodic Table thereunder. Elements Diamond Silicon Germanium Inorganic compounds or compositions Halides Phosphates Oxides Aluminium oxides Complex oxides Complex oxides What are earth copper oxides, e.g. high T-superconductors} with formula AMeO ₃ , wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or Al, e.g. ortho ferrites with formula BMe ₂ O ₄ , wherein B is Mg, Ni, Co, Al, Zn, or Cd and Me is Fe, Ga, Sc, Cr, |

| 29/28 | • • • with formula A ₃ Me ₅ O ₁₂ wherein A is a rare earth metal and Me is Fe, Ga, Sc, Cr, Co or | 31/08 | the diffusion materials being a compound of the elements to be diffused |
|---|--|--|---|
| | Al, e.g. garnets | 31/10 | Reaction chambers; Selection of materials |
| 29/30 | Niobates; Vanadates; Tantalates | 31/10 | therefor |
| 29/32 | Titanates; Germanates; Molybdates; Tungstates | 31/103 | • • {Mechanisms for moving either the charge or heater} |
| 29/34 | Silicates | 31/106 | {Continuous processes} |
| 29/36 | Carbides | 31/12 | Heating of the reaction chamber |
| 29/38 | Nitrides | 31/14 | Substrate holders or susceptors |
| 29/40 | A_{III}B_V compounds {wherein A is B, Al, Ga, In or Tl and B is N, P, As, Sb or Bi} | 31/16 | • • Feed and outlet means for the gases; Modifying the flow of the gases |
| 29/403 | $\cdot \cdot \cdot \{A_{III}$ -nitrides $\}$ | 31/165 | {Diffusion sources} |
| 29/406 | {Gallium nitride} | 31/18 | Controlling or regulating |
| 29/42 | Gallium arsenide | 31/185 | • • • {Pattern diffusion, e.g. by using masks} |
| 29/44 | Gallium phosphide | 31/20 | Doping by irradiation with electromagnetic waves |
| 29/46 | Sulfur-, selenium- or tellurium-containing | | or by particle radiation |
| | compounds | 31/22 | • • by ion-implantation |
| 29/48 | $A_{II}B_{VI}$ compounds {wherein A is Zn, Cd or Hg, and B is S, Se or Te} | 33/00 | After-treatment of single crystals or homogeneous polycrystalline material with defined structure |
| | | | polyci ystannic material with defined structure |
| 29/50 | Cadmium sulfide | | (C30B 31/00 takes precedence) |
| 29/50 29/52 | Alloys | 33/005 | (C30B 31/00 takes precedence) |
| | | 33/005 33/02 | • {Oxydation} |
| 29/52 29/54 29/56 | Alloys Organic compounds Tartrates | 33/005 33/02 | {Oxydation} Heat treatment (<u>C30B 33/04</u>, <u>C30B 33/06</u> take |
| 29/52 29/54 29/56 29/58 | . Alloys. Organic compounds. Tartrates. Macromolecular compounds | 33/02 | {Oxydation} Heat treatment (<u>C30B 33/04</u>, <u>C30B 33/06</u> take precedence) |
| 29/52 29/54 29/56 29/58 29/60 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape | | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation |
| 29/52 29/54 29/56 29/58 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} | 33/02 33/04 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals |
| 29/52 29/54 29/56 29/58 29/60 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented | 33/02 33/04 33/06 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} | 33/02 33/04 33/06 33/08 | {Oxydation} Heat treatment (<u>C30B 33/04</u>, <u>C30B 33/06</u> take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles | 33/02 33/04 33/06 33/08 33/10 33/12 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs | 33/02 33/04 33/06 33/08 33/10 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, | 33/02 33/04 33/06 33/08 33/10 33/12 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or after- |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 29/66 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders | 33/02 33/04 33/06 33/08 33/10 33/12 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or aftertreatment of single crystals or of a homogeneous |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders Crystals with laminate structure, e.g. | 33/02 33/04 33/06 33/08 33/10 33/12 35/00 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or aftertreatment of single crystals or of a homogeneous polycrystalline material with defined structure |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 29/66 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders | 33/02 33/04 33/06 33/08 33/10 33/12 35/00 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or aftertreatment of single crystals or of a homogeneous polycrystalline material with defined structure {Crucibles or containers} |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 29/66 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders Crystals with laminate structure, e.g. "superlattices" Production of single crystals or homogeneous | 33/02 33/04 33/06 33/08 33/10 33/12 35/00 35/002 35/005 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or after-treatment of single crystals or of a homogeneous polycrystalline material with defined structure {Crucibles or containers} {Transport systems} |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 29/66 29/68 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders Crystals with laminate structure, e.g. "superlattices" Production of single crystals or homogeneous polycrystalline material with defined structure | 33/02 33/04 33/06 33/08 33/10 33/12 35/00 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or aftertreatment of single crystals or of a homogeneous polycrystalline material with defined structure {Crucibles or containers} {Transport systems} {Apparatus for preparing, pre-treating the source |
| 29/52 29/54 29/56 29/58 29/60 29/602 29/605 29/62 29/64 29/66 29/68 | Alloys Organic compounds Tartrates Macromolecular compounds characterised by shape {Nanotubes} {Products containing multiple oriented crystallites, e.g. columnar crystallites} Whiskers or needles Flat crystals, e.g. plates, strips or discs Crystals of complex geometrical shape, e.g. tubes, cylinders Crystals with laminate structure, e.g. "superlattices" Production of single crystals or homogeneous | 33/02 33/04 33/06 33/08 33/10 33/12 35/00 35/002 35/005 | {Oxydation} Heat treatment (C30B 33/04, C30B 33/06 take precedence) using electric or magnetic fields or particle radiation Joining of crystals Etching in solutions or melts in gas atmosphere or plasma Apparatus not otherwise provided for, specially adapted for the growth, production or after-treatment of single crystals or of a homogeneous polycrystalline material with defined structure {Crucibles or containers} {Transport systems} |

NOTE

conditions

When classifying in this group, classification is also made in groups $\underline{\text{C30B 1/00}}$ - $\underline{\text{C30B 27/00}}$ according to the process of crystal growth.

30/02 . using electric fields, e.g. electrolysis

30/04 . using magnetic fields30/06 . using mechanical vibrations

30/08 • in conditions of zero-gravity or low gravity

After-treatment of single crystals or homogeneous polycrystalline material with defined structure

| 31/00 | Diffusion or doping processes for single crystals or homogeneous polycrystalline material with defined structure; Apparatus therefor |
|--------|--|
| 31/02 | by contacting with diffusion materials in the solid state |
| 31/04 | by contacting with diffusion materials in the liquid state |
| 31/045 | • • {by electrolysis} |
| 31/06 | • by contacting with diffusion material in the gaseous state |